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N-Channel SuperFET[®] II MOSFET

800 V, 3.5 A, 2.25 Ω

FCPF2250N80Z

Features

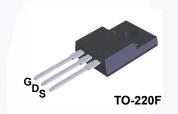
- R_{DS(on)} = 1.8 Ω (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 11 nC)
- Low E_{oss} (Typ. 1.1 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 51 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

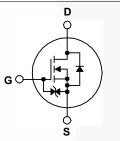
Applications

- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

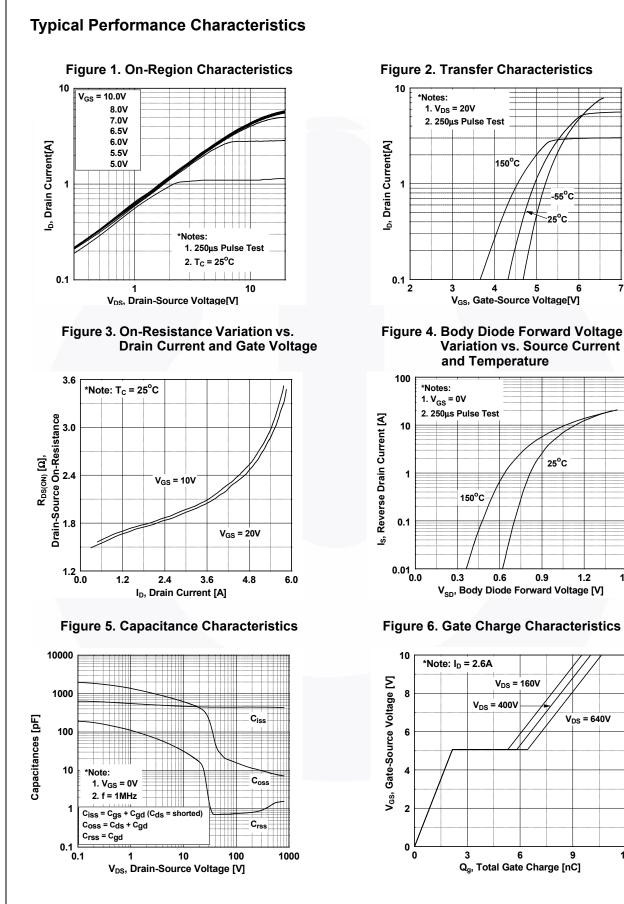
Symbol		FCPF2250N80Z	Unit			
V _{DSS}	Drain to Source Voltage		800	V		
V _{GSS}	Cata ta Sauraa Valtaga	- DC	- DC			
	Gate to Source Voltage	- AC	- AC (f > 1 Hz)			
ID	Drain Current	- Continuous (T _C = 25 ^o C)	3.5*	Α		
	Drain Current	- Continuous (T _C = 100 ^o C)	- Continuous (T _C = 100 ^o C)			
I _{DM}	Drain Current	- Pulsed	(Note 1)	6.5*	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			21.6	mJ	
I _{AR}	Avalanche Current (Note			0.52	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)			0.22	mJ	
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt	20				
P _D	Power Dissipation	(T _C = 25°C)		21.9	W	
	Fower Dissipation	- Derate Above 25°C		0.18	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	
Drain current limited	d by maximum junction temperature, with h	eatsink.			·	

Thermal Characteristics

Symbol	Parameter	FCPF2250N80Z	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	5.7	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	0/10	

August 2015

		FCPF2250N80Z	TO-2	220F	Tube	NI/A		NI/A		F0
				ckagePacking MethodReel S-220FTubeN/A			N//			50 units
	Chara		5 ^o C unle	ess othe	erwise noted.					
Symbol		Parameter			Test Conditions			Тур.	Max.	Unit
Off Charact	teristics									
BV _{DSS}	1	Source Breakdown Volta	ae	V _{CS} =	0 V, I _D = 1 mA, T _J = :	25°C	800	-	-	V
ABV _{DSS}	Breakdown Voltage Temperature		•					0.95		V/ºC
$/\Delta T_{J}$	Coefficient			$I_D = 1 \text{ mA}$, Referenced to 25° C			-	0.85	-	V/°(
I _{DSS}	Zero Gate Voltage Drain Current			V _{DS} = 800 V, V _{GS} = 0 V			-	-	25	μA
USS				V_{DS} = 640 V, V_{GS} = 0 V, T_C = 125°C			-	-	- 250	μΛ
I _{GSS}	Gate to B	to Body Leakage Current			±20 V, V _{DS} = 0 V		-	-	±10	μA
On Charact	teristics									
V _{GS(th)}	Gate Thre	eshold Voltage		V _{GS} =	V _{DS} , I _D = 0.26 mA		2.5	-	4.5	V
R _{DS(on)}	Static Dra	ain to Source On Resista	ance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 1.3 \text{ A}$			-	1.8	2.25	Ω
9 _{FS}	Forward ⁻	Transconductance		V _{DS} = 20 V, I _D = 1.3 A			-	2.28	-	S
Dynamic Cl C _{iss} C _{oss} C _{rss}	Input Cap Output Ca			V _{DS} = f = 1 N	100 V, V _{GS} = 0 V, IHz		-	440 16 0.75	585 22 -	pF pF
C _{oss}	Output Ca	apacitance		V _{DS} = 480 V, V _{GS} = 0 V, f = 1 MHz			-	8.4	-	pF
C _{oss(eff.)}	Effective	ctive Output Capacitance		$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$			-	51	-	pF
Q _{g(tot)}	Total Gate	e Charge at 10V		$V_{DS} = 640 \text{ V}, \text{ I}_{D} = 2.6 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)			-	11	14	nC
Q _{gs}	Gate to S	ource Gate Charge				-	2.2	-	nC	
Q _{gd}	Gate to D	rain "Miller" Charge				(Note 4)	-	4.3	-	nC
ESR	Equivaler	nt Series Resistance		f = 1 N	IHz		-	2.8	-	Ω
Switching (Characte	eristics								
t _{d(on)}	Turn-On I	Delay Time		V_{DD} = 400 V, I _D = 2.6 A, V _{GS} = 10 V, R _g = 4.7 Ω			-	11	32	ns
t _r	Turn-On I	Rise Time				-	6.7	23	ns	
t _{d(off)}	Turn-Off I	Delay Time				-	26	62	ns	
t _f	Turn-Off I	Fall Time		(Note 4)				8.7	27	ns
Drain-Sour	ce Diod	e Characteristics								
I _S	Maximum Continuous Drain to Source Diode Forward Current					-	-	3.5	А	
I _{SM}	Maximum Pulsed Drain to Source Diod			e Forward Current			-	-	6.5	Α
V _{SD}	Drain to S	Source Diode Forward V	/oltage	V _{GS} = 0 V, I _{SD} = 2.6 A			-	-	1.2	V
t _{rr}	Reverse I	Recovery Time		V _{GS} = 0 V, I _{SD} = 2.6 A,		-	260	-	ns	
	Reverse I	Recovery Charge		dI _F /dt = 100 A/μs			-	2.2	-	μC



-55°C 25°C

6

25°C

1.2

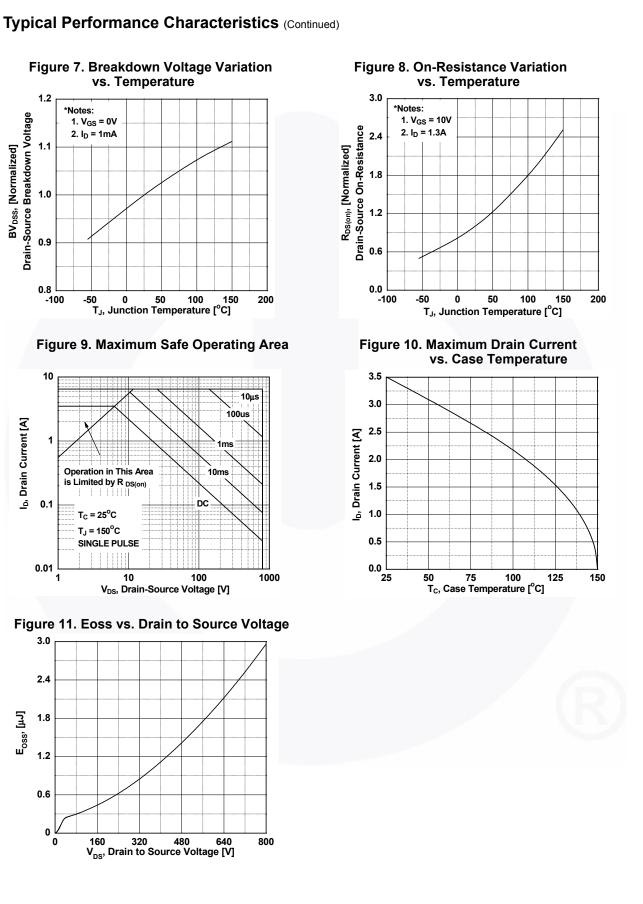
V_{DS} = 640V

9

1.5

7

12



FCPF2250N80Z — N-Channel SuperFET[®] II MOSFET

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1.2

1.1

1.0

0.9

0.8

10

1

0.1

0.01

3.0

2.4

1.2

0.6

0

0

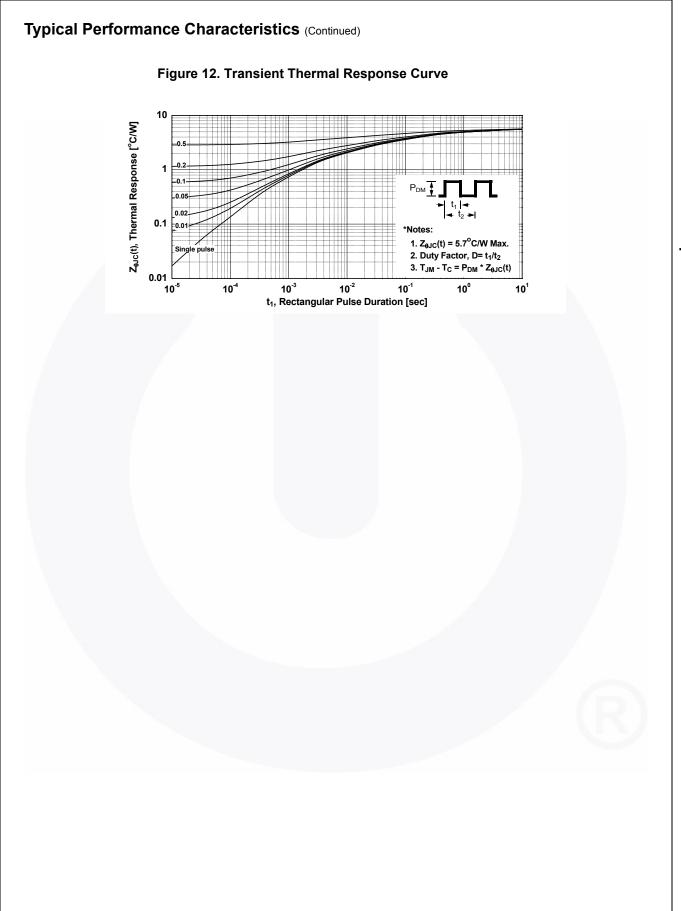
E_{oss}, [µJ] 1.8 1

I_b, Drain Current [A]

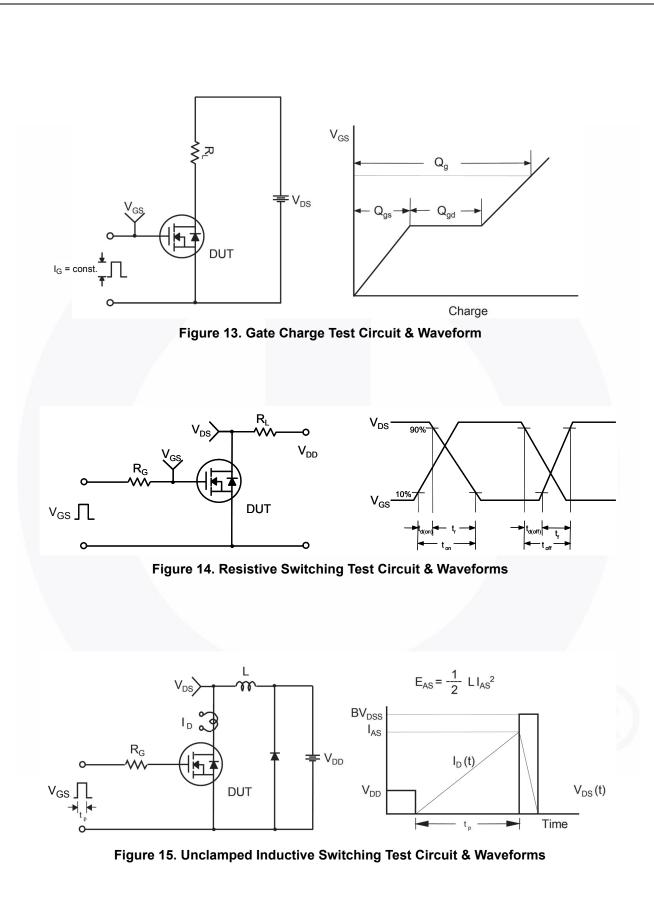
-100

Drain-Source Breakdown Voltage

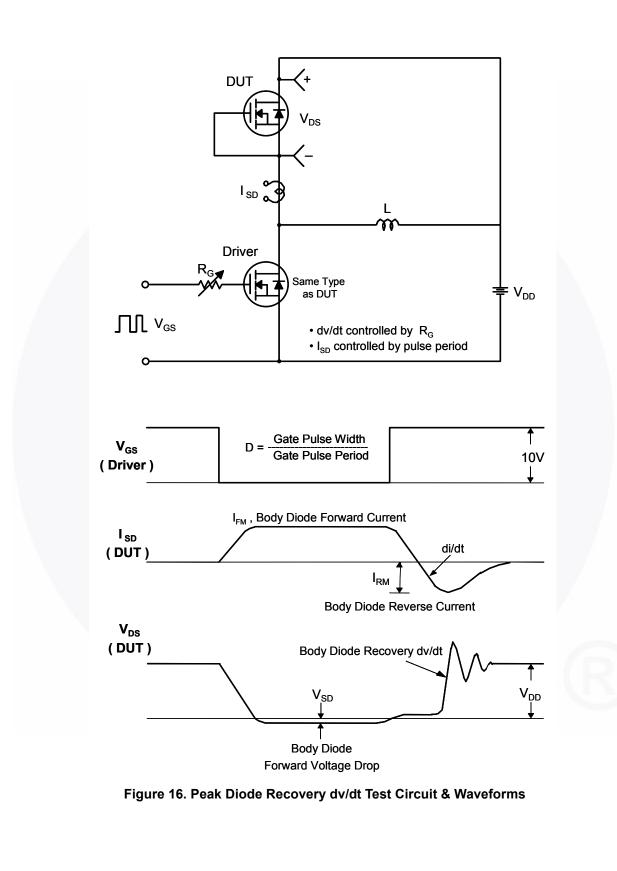
BV_{DSS}, [Normalized]

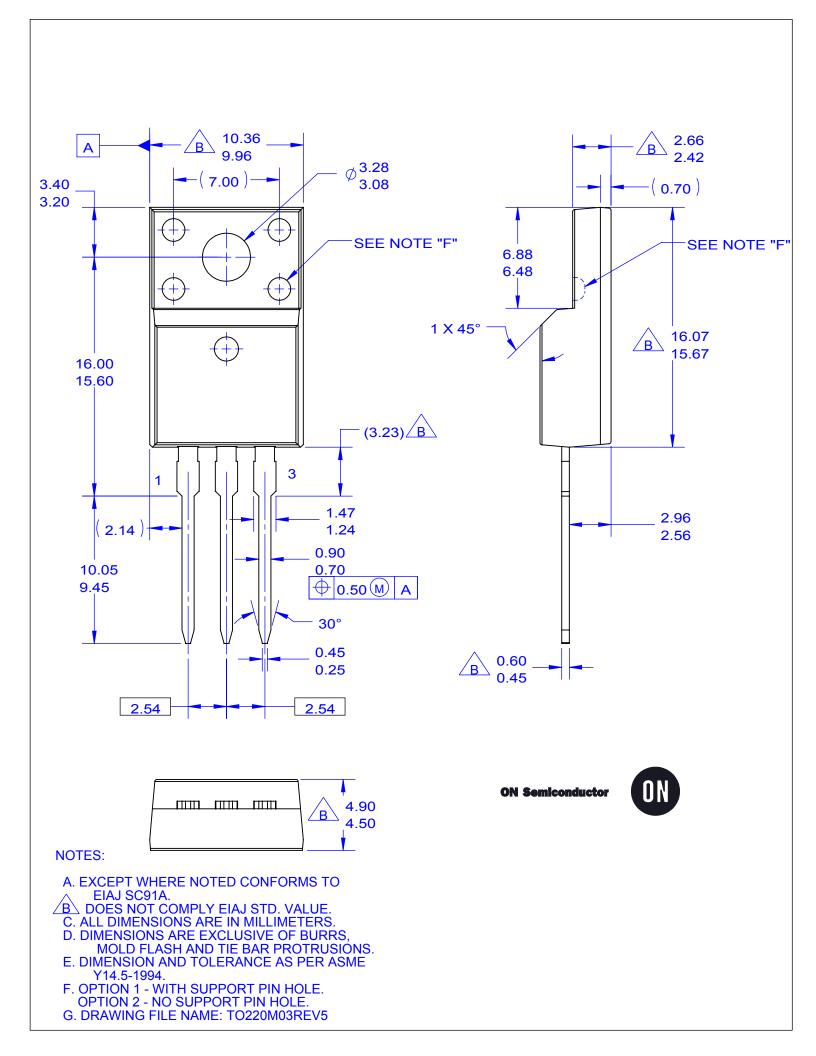


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FCPF2250N80Z — N-Channel SuperFET[®] II MOSFET





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